Pansmitted herewith for filing is the Patent Application of:

Inventor: PAUL KWOK KEUNG HO, MEI SHENG ZHOU AND CHOCKALINGAM RAMASAMY

For: IMPROVED CHEMICAL AGENT ADDITIVES IN COPPER CMP SLURRY

Enclosed are:

fir:

  $X = \frac{5}{2}$  sheets of drawing(s) - formal.

X An assignment of the invention to Chartered Semiconductor Manufacturing Ltd.

An associate power of attorney

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A	SMALL ENTITY
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 690.
TOTAL CLAIMS	<b>18</b> -20=	0	x 18 =	<b>\$</b> 0.
INDEP CLAIMS	<b>3</b> -3=	0	x 78 =	\$ 0.
MULTIPLE DEPENDENT CLAIM PRESENTED + 260 =				
SUB TOTAL				\$ <b>690</b> .
ASSIGNMENT			\$40.	
			OTAL	\$ 730.

Please charge my Deposit Account No. 19-0033 in the amount of \$ 730. A duplicate copy of this sheet is enclosed.

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X Any additional filing fees required under 37 CFR §1.16.

x Any patent application processing fees under 37 CFR §1.17.

Respectfolly submitted,

STERBAN B. ACKERMAN, REG. NO. 37,761